



Bringing Super Computing to the Masses

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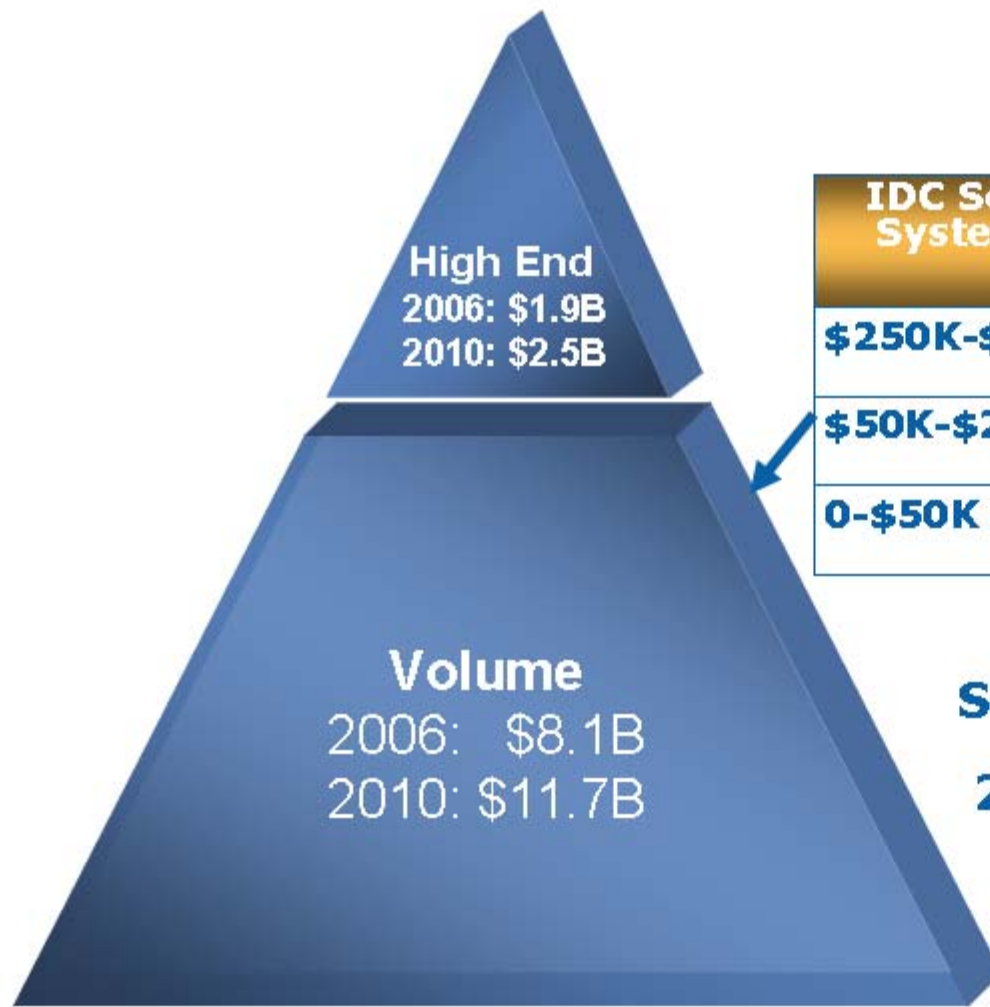
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IDC Prediction of HPC Market Growth



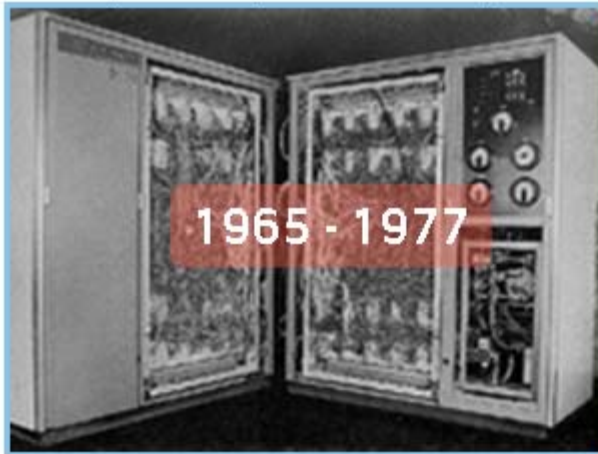
IDC Segment System Size	2006	2010	CAGR
\$250K-\$1M	\$2.1B	\$3.4B	11.8%
\$50K-\$250K	\$3.6B	\$4.9B	10.7%
0-\$50K	\$2.5B	\$3.4B	9.6%

Segment Total 2006: \$10.0B
2010 forecast: \$14.3B

- Source: IDC Worldwide Technical Computing Systems Revenue 2006-2010 #201733 May 2006.
- Source: IDC Technical Server QView February 2007 for 2006 actual data

Yesterday's Supercomputer is Today's PC

CDC 6600 - First
successful
Supercomputer 9MFlops



ASCI Red
(world fastest on top500 till 2000)
First Teraflop Computer,
9298 Intel Pentium® II Xeon Processors



2005

XBOX 360
1 TFlops

1TFlops with just a game Console

Yesterday

Today



VIRTUAL WORLDS

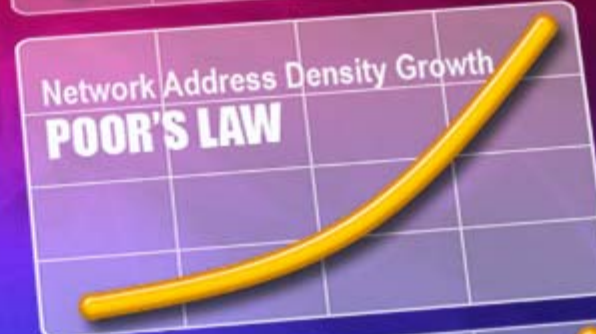
THE RISE OF THE 3D INTERNET

Justin Rattner

Intel Developer Forum

October 2007

Accelerating Technology and Capacity **GROWTH CURVES**



Source: metaverseraodmap.org

The Transition to the 3D INTERNET



Virtual Worlds Provide The Richest Space In Which To Understand The 3D Internet

Flavors of VIRTUAL WORLDS

WoW



**MULTI-PLAYER
GAMES**

Croquet



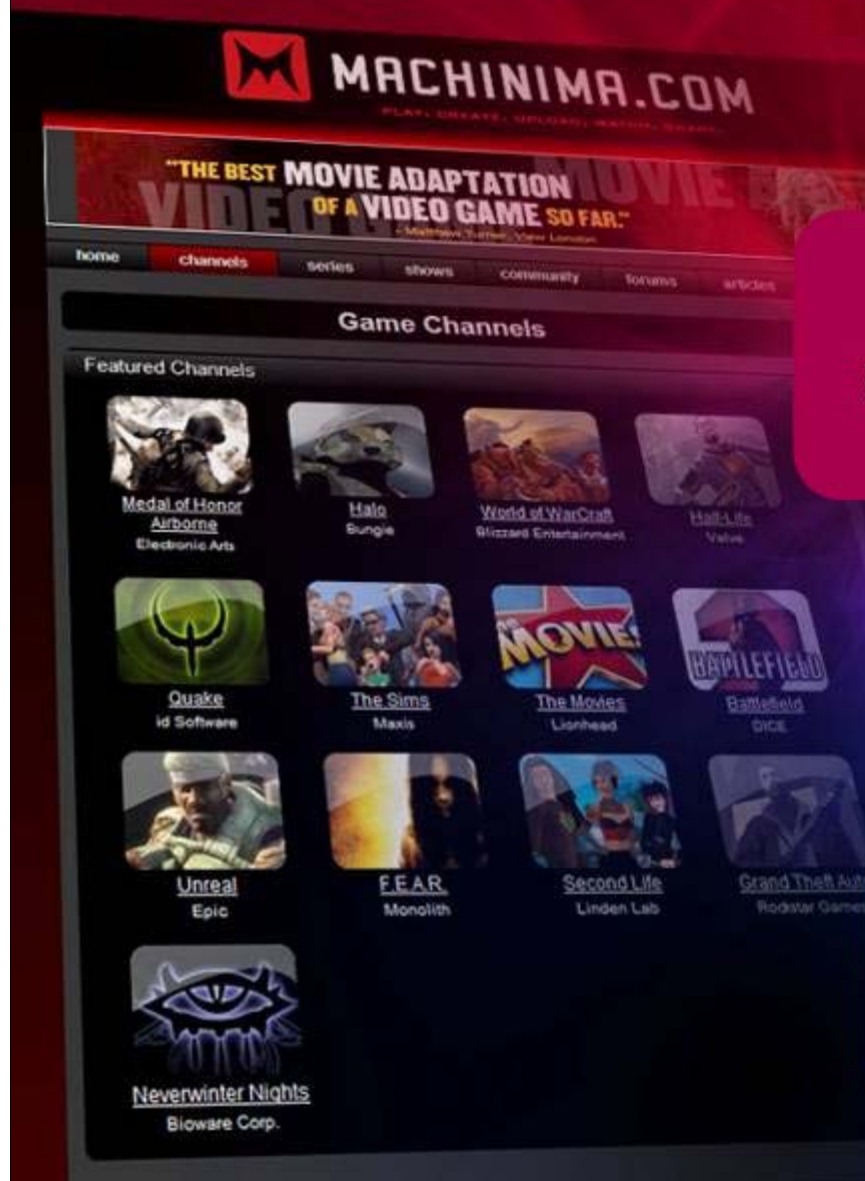
METAVERSES

Fully Immersive
3D Virtual Spaces

Second Life



Flavors of VIRTUAL WORLDS



PARAVERSE
Real + Virtual Mashups

Virtual Surgery



Mscape

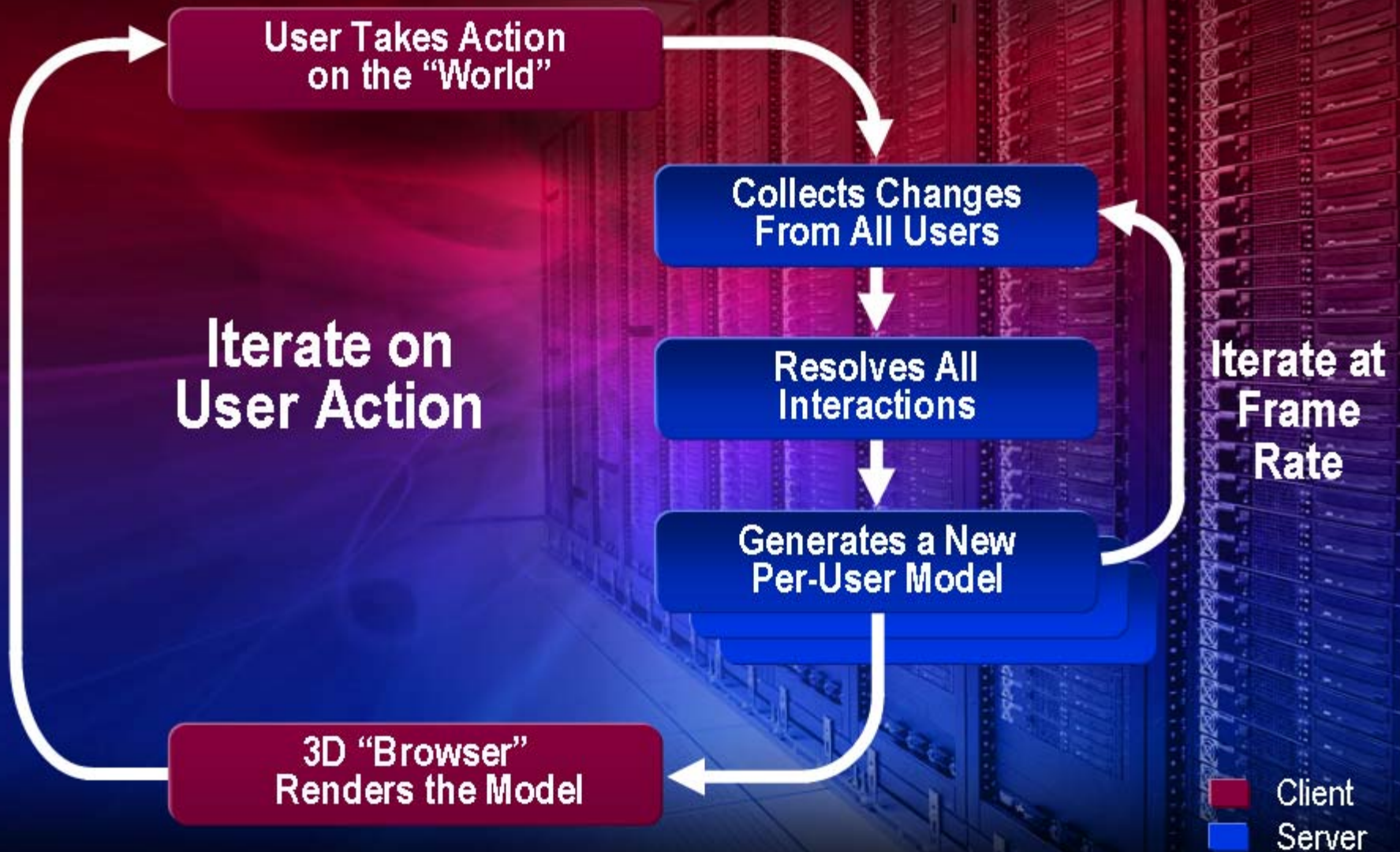


globalkids.org



MACHINIMA
Interactive Cinema

3D Internet Simulation Loop



DEMANDS on Server Performance

75%+

Time Spent in Compute-Intensive Components

Unlike 2D Internet Server Side:

- Floating Point, Matrix Intensive
- Quadratic Growth

Server Performs an Order of Magnitude More Work

TYPE	SOFTWARE	MAXIMUM CLIENT/ SERVER
MMORPGS	Eve Online	34420
	WoW	2500
VWs	Second Life	160

VW's Require 10-100x More Computation Per Client Than MMORPGS

DEMANDS on Client Performance

65%+

Time spent in Compute-Intensive Components

Unlike 2D Internet Client Side:

- Floating Point, Matrix Intensive
- Quadratic Growth in Compute

Client CPU/GPU Performance *2D Internet Vs. 3D Internet*

APPLICATION	% CPU UTILIZATION	% GPU UTILIZATION (nVidia G80)
2D Websites	20	0-1
Google Maps	60	3-5
Google Earth	50	10-15
Second Life	70	35-75

VW's Need At Least 3x CPU, 20x GPU Processing Compared To 2D

DEMANDS on Network Performance



**VW's Need At Least 100x Bandwidth
Compared To MMORPGS**

Cinematic Quality Realism*

Reflection



*Nature***



Shadow



Progress in Ray Tracing



IDF 2004

50 Intel® Xeon™
Processors

4 Frames per Second
640x480

Games Convention 2007

Yorkfield
(45nm Quadcore)

~90 frames per Second
768x768

Fall IDF 2007

Dual-X5365
(total: 8 cores)

~90 frames per Second
1280x720

More Engaging Human-Computer Interface

Haptics



Facial Tracking



3D Mouse



Open GL Printers



Screen Technologies



High Performance Computing - Serving People from Grand Scientific Problems Today to Our Daily Lives Tomorrow



In the '90s, corporations will boost workplace efficiency by connecting individual PCs into powerful networks. This can now be accomplished thanks to the 1.2 million transistor Intel486™ DX, the first of a new series of powerful CPUs for office computing.



Intel designs embedded control products for the automotive industry. Our microcontroller is the "brains" behind electronically-braked suspension systems, engine controls, anti-lock braking systems (ABS), traction control and steering systems.



The industrial sector is second to office automation in total consumption of Intel embedded control products. Process controllers, material handling systems and sophisticated robots are just a few of the many applications. IBM® real-time operating system software links computing modules, such as communications controllers and factory equipment. At last count, more than 300,000 microprocessors were running IBM systems software, making it the most widely used real-time OS in the world.

Intel's EtherExpress™ and TokenExpress™ cards let even intranetted users hook themselves up to PC networks. The card just slots into an open slot in the PC-making installation a snap.



Powered by hundreds of Intel 486™ microprocessors, the TouchStone



10-inch wafers will soon give way to a new industry standard that will increase yield and produce eight-inch wafers. Speed to market will be critical.

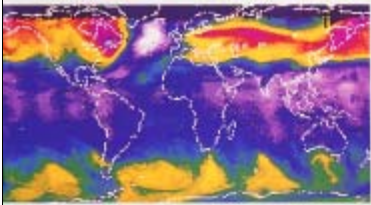
Continuous process improvement, Intel has achieved to make our products more powerful, more compact, more efficient, multimedia solutions and systems, and networking products now complement our line of advanced microprocessors. Intel continues to diversify its technology at a blistering pace. Where will the future take us? That may be influenced by you.

ENCUMBERED BY PAST HISTORY.

A year after Dr. Noyce spoke these words, Intel introduced the 4004, a revolutionary chip containing 2,300 transistors. Today, Intel envisions development of a microprocessor containing 100 million transistors—the literal equivalent of a human brain. For over 20 years, Intel has been synonymous with the leading-edge of technology. Always with an eye for con-

GO OFF AND DO SOMETHING WONDERFUL.
—Robert N. Noyce, 1970

Intel was the world's first electronics company to begin fabrication of some-depositing substances from its worldwide systems manufacturing processes. All Intel manufacturing processes will be CPU-free by the end of 1992.



Digital Video Interactive technology brings more to the PC. Full screen, full motion video, 500 images, Graphics, Stereo sound. All in an interactive environment. Develops products (VAT) applications for fields such as training, real estate sales, education and manufacturing process analysis.

Original Equipment Manufacturers building blocks. OEMs now design, trace and expense by purchasing Intel components of higher levels of integration.



Intel processors take place in Santa Clara and Sacramento, CA; Portland, OR; Phoenix, AZ; Houston, TX; and Singapore, SG. Intel also conducts overseas manufacturing in Ireland, Israel, the Philippines and Malaysia.



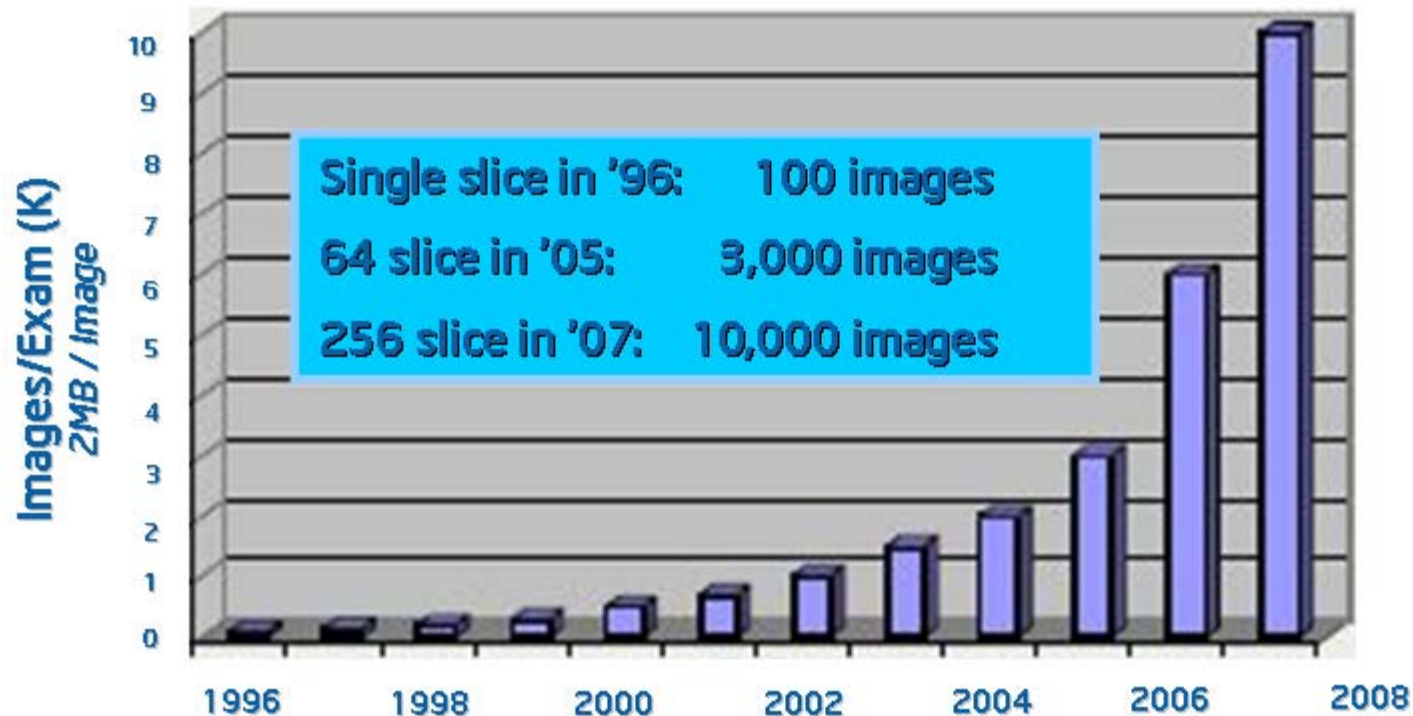
This cow's necktie is actually an identification transponder collar equipped with an embedded control chip. It provides feedback to computer systems that track daily food intake and the milk output of each cow in the herd.



"Don't be encumbered by past history. Go off and do something wonderful." - Robert Noyce, Intel, 1970



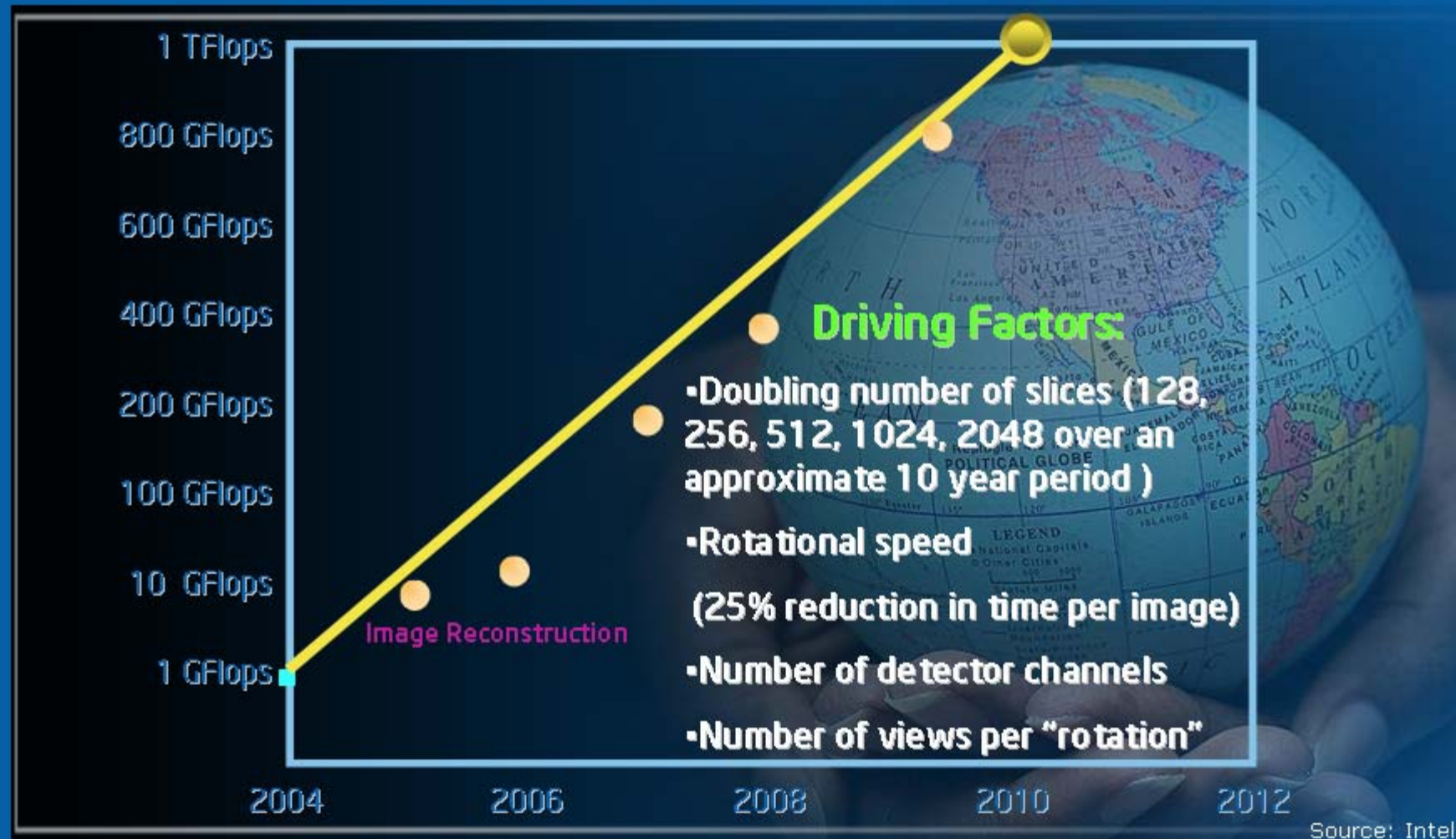
Exploding Medical Imaging Data Processing



Source: Intel

- 3-D renderings of the images
- Computer aided diagnostic algorithms
- Fusions of images from different modalities
 - MRI, CT, PET, and SPECT
- Real-time applications are appearing

Global Healthcare will Reach the Masses *with Ever Increasing Accuracy*



Data changes the game in Client Computing



[Kasparov vs. Deep Blue]

Rule-based system exceeds human performance in a structured, deterministic domain



Statistical inference (not rules)

- 100s of TB of training data
- Racks of computation



Google Translate BETA

Text and Web | [Translated Search](#) | [Dictionary](#) | [Tools](#) | [Help](#)

Translate Text

Original text:

The Tech Museum of Innovation is honoring Gordon Moore with the 2007 Global Humanitarian Award for his contributions to global environmental conservation, science, higher education and quality of life.

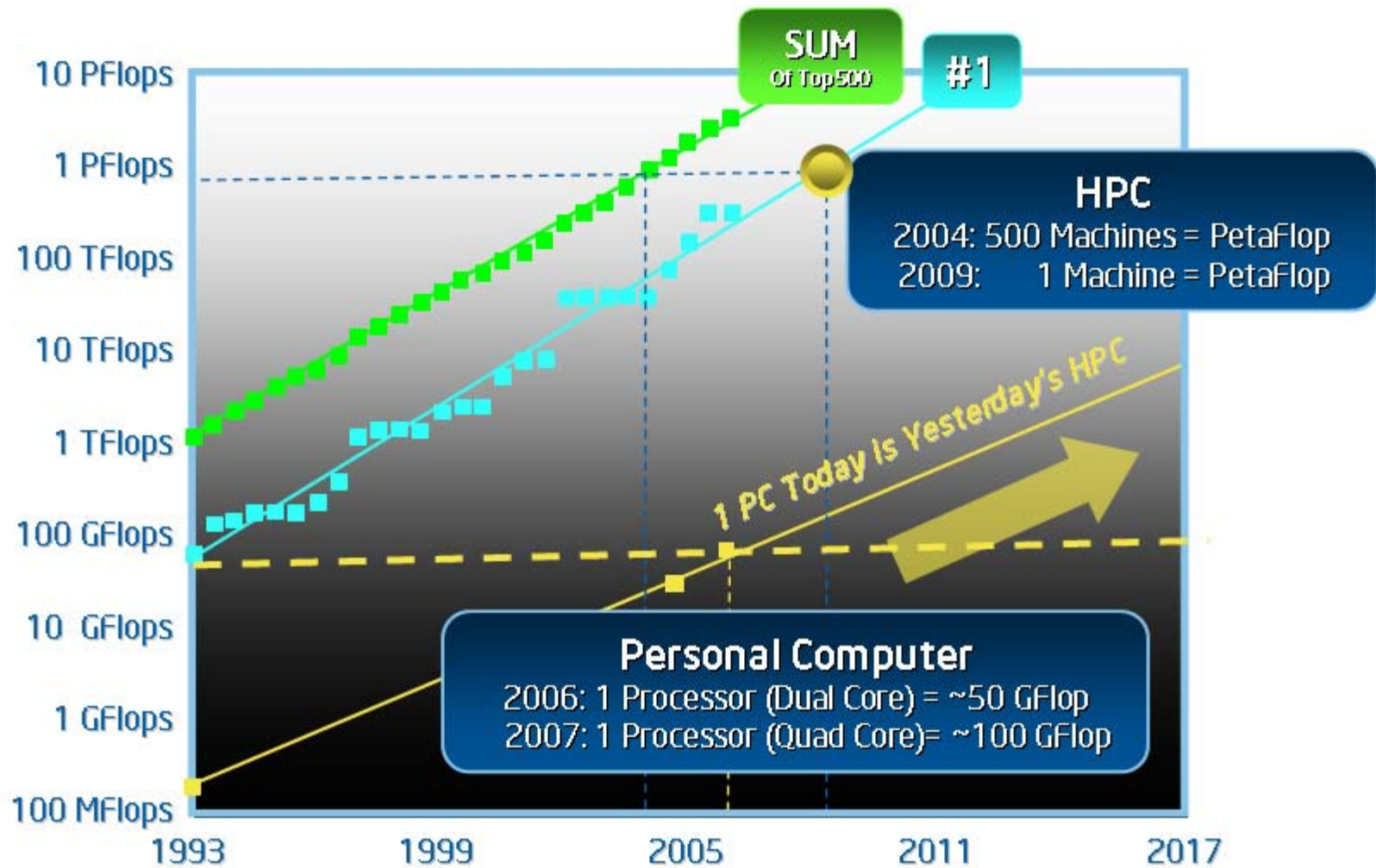
Automatically translated text:

فإن متحف التكنولوجيا لابتكار هو تكريم غوردون مور مع 2007 الانساني العالمي جائزة لاسهاماته العالمية واحفاظة على البيئة ، والعلوم ، والتعليم العالي ونوعية الحياة.

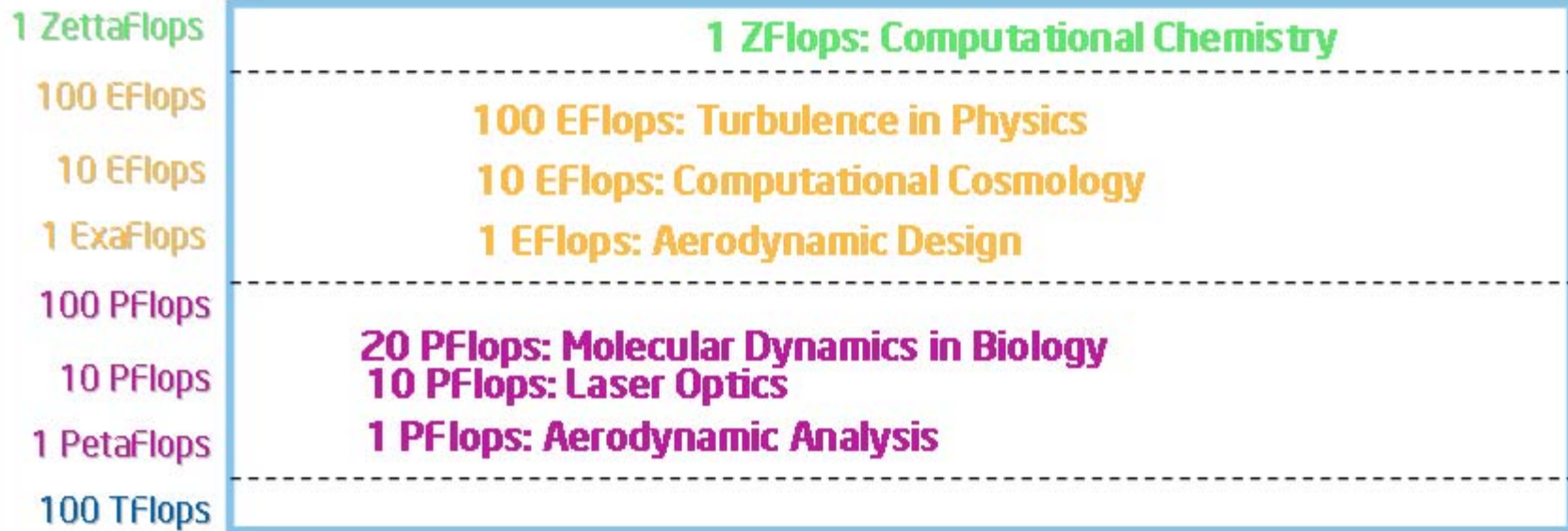
English to Arabic | Translate | [Suggest a better translation](#)

Today

The Top500 Illustration



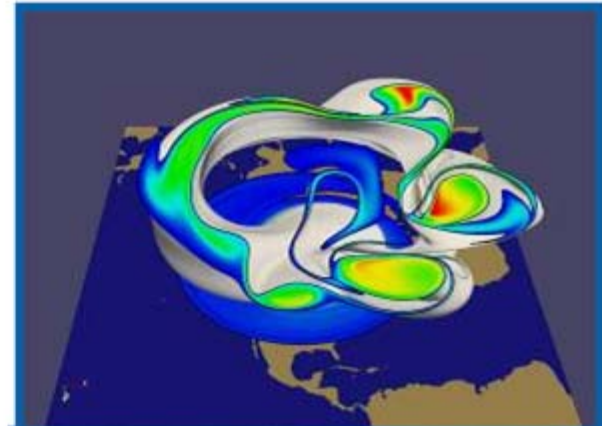
Insatiable Future Super Computing Demand



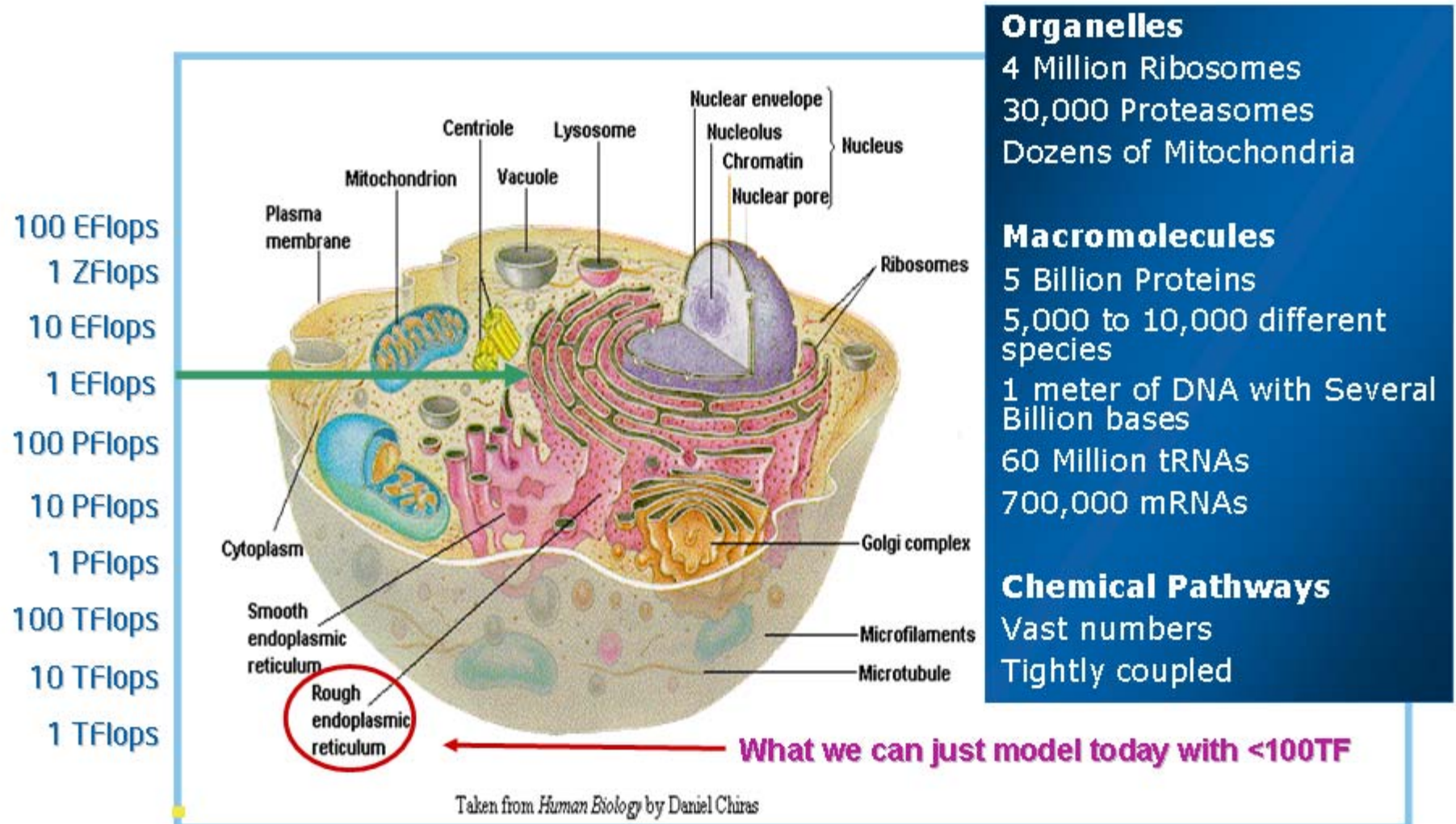
Source: Dr. Steve Chen, "The Growing HPC Momentum in China," June 30th, 2006, Dresden, Germany

Applications Demand Petascale

- Many believe that global warming will produce more extremes weather (drought/flooding).
- Current models are too coarse for predicting climate change at the national level.
- To predict regional climate change:
 - Community climate model resolution goal is *10 km*
 - Currently can simulate *50 days/day* on Red Storm at 10 km using NCAR/SNL SEAM
 - Typical climate simulation is for *100 yrs.*



Computing that is Impossible Today



1993

1999

2005

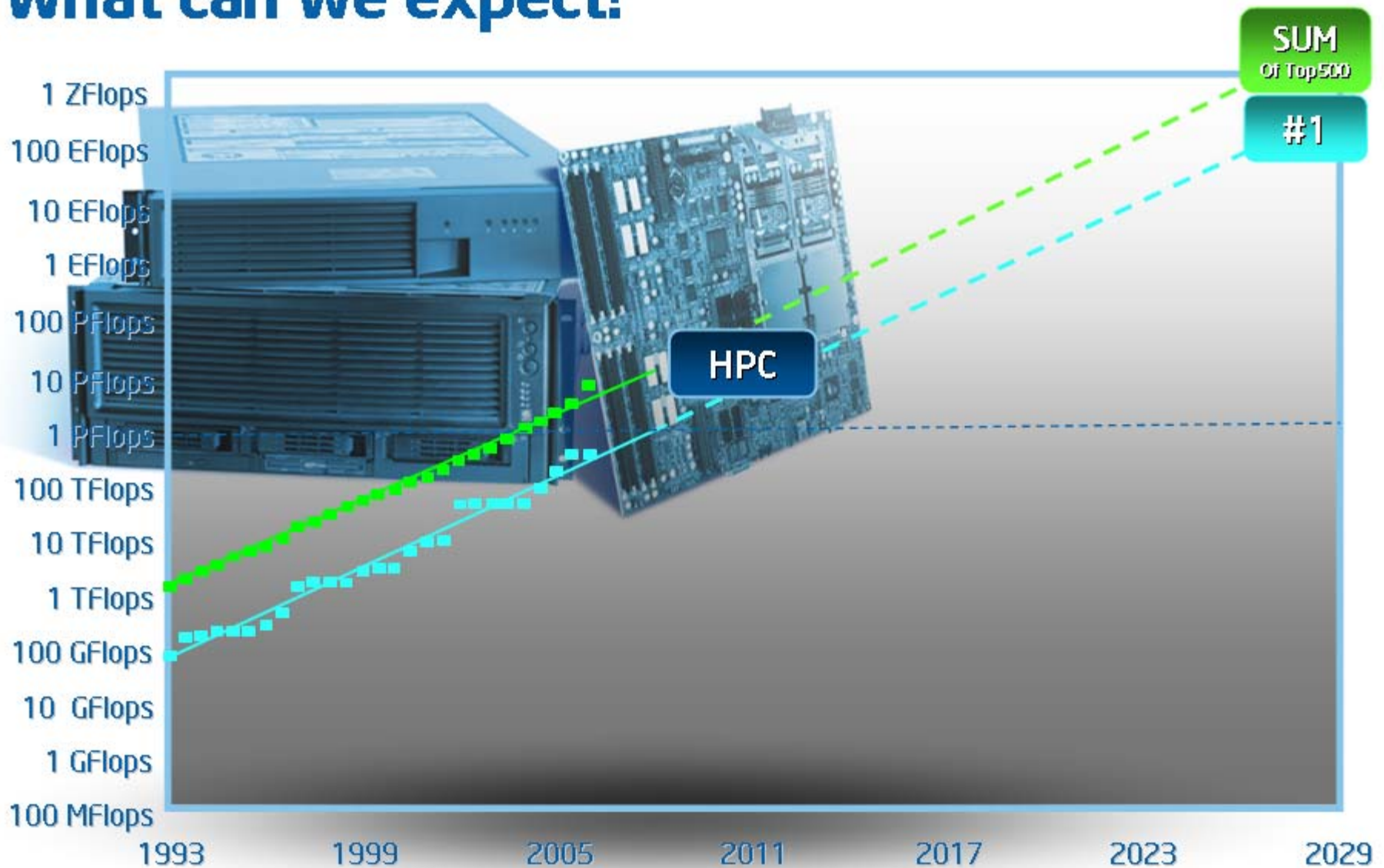
2011

2017

2023

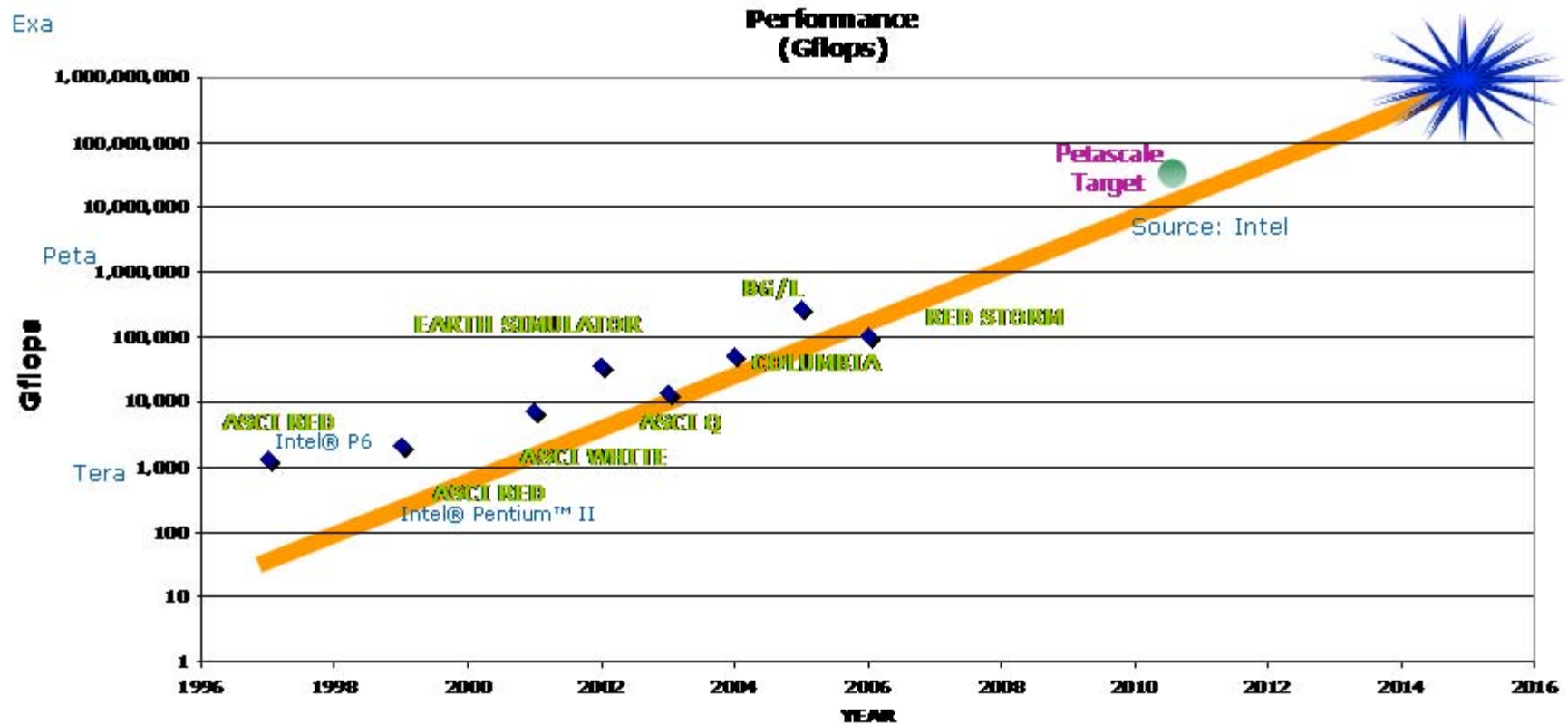
2029

What can we expect!



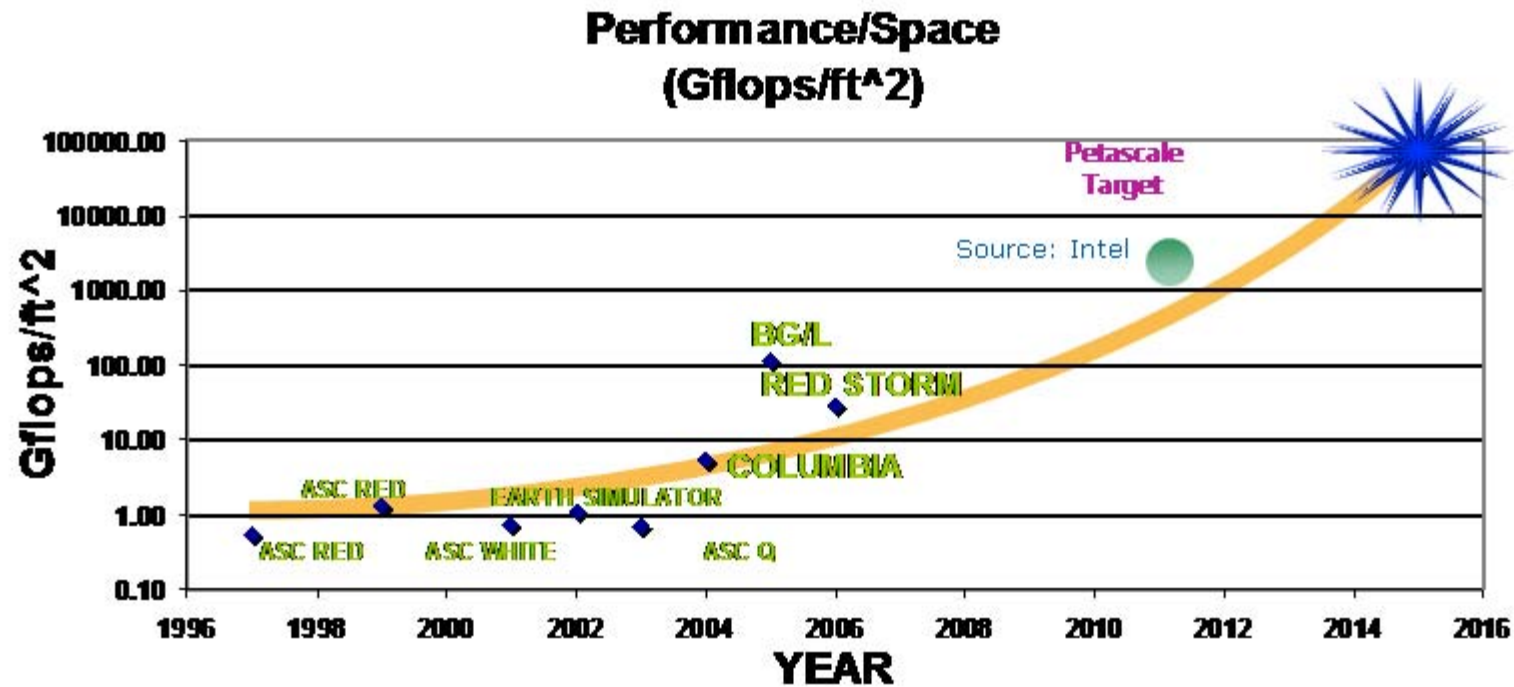
Performance Acceleration

Marching Towards Petascale and Beyond



Source: Exascale Study Group

Technologies Improve Performance vs. Area

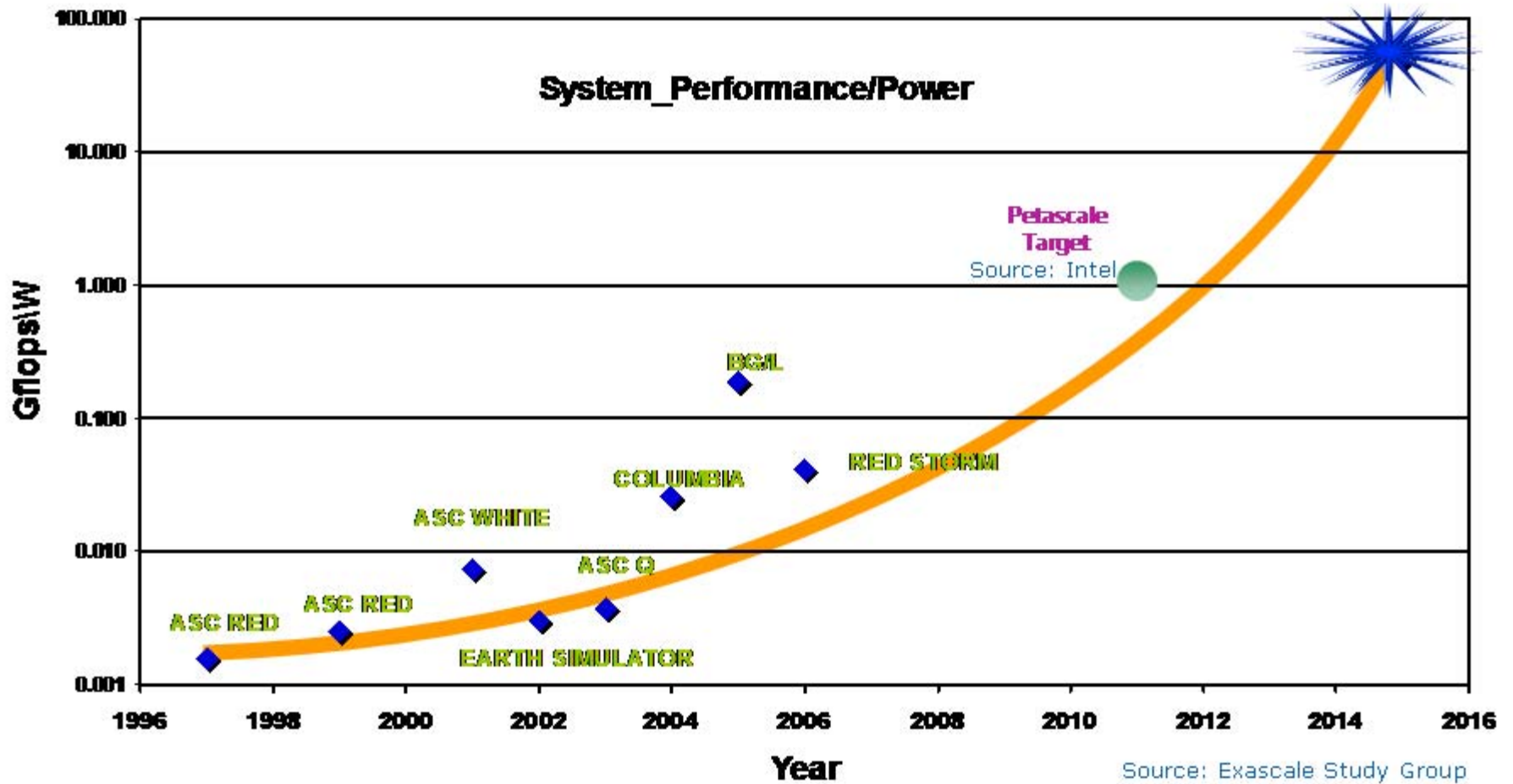


Source: Exascale Study Group

CDC 6600 filled ~500 ft² of floor space
1965

The CRAY-XMP occupied ~100 ft²
1984

Performance vs. Power



Grand Challenge Problems Break All Rule of Thumb



~~\$10-20 Million?~~



> \$100 Million



~~Watt~~



Mega Watt



~~> 100 sqft~~



>Thousands of sqft



~~Countable Processors~~



Millions of Cores and Sockets

What Brings HPC to the Masses?

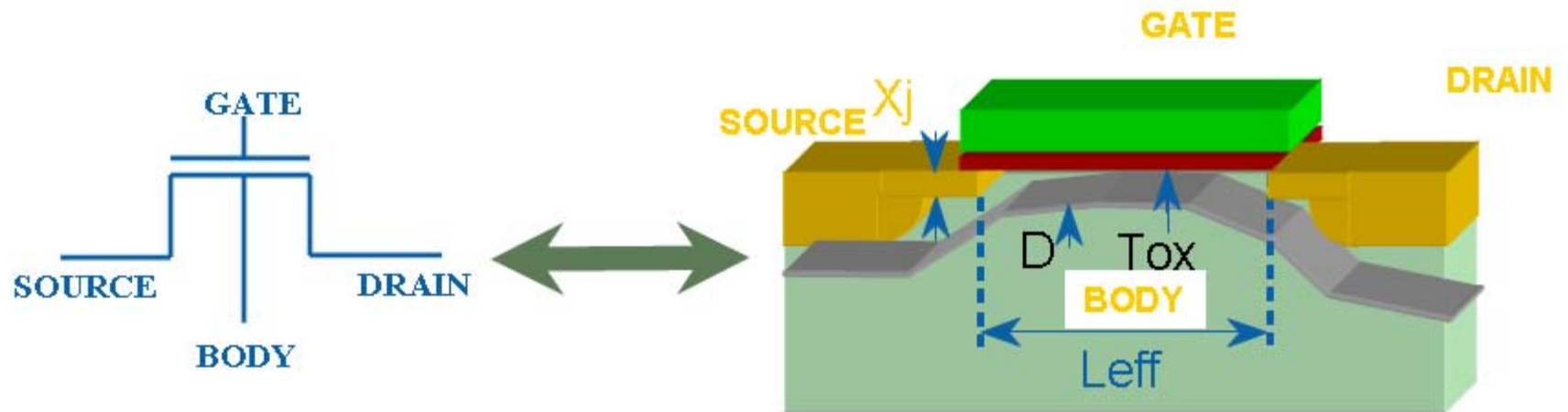
Technology

Performance

Power

Area & Cost

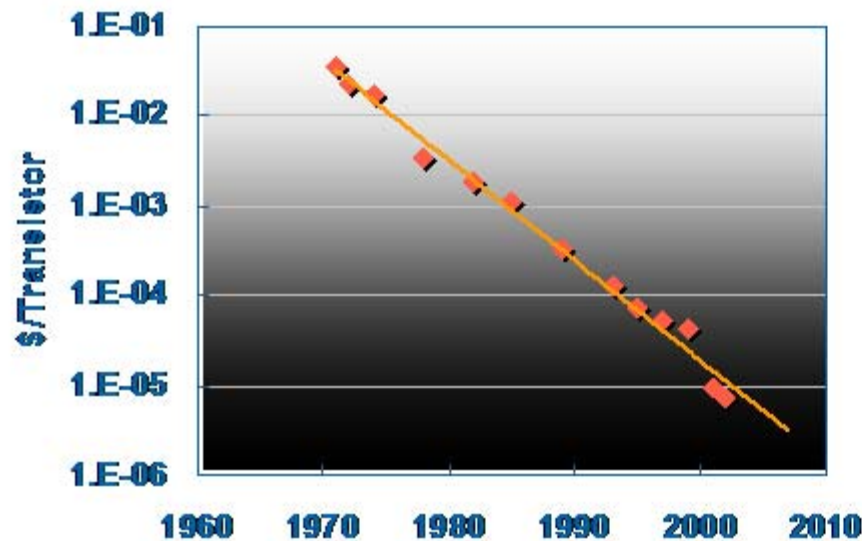
Technology Scaling



Dimensions scale down by 30%	Doubles transistor density
Oxide thickness scaling	Faster transistor, higher performance
Vdd & Vt scaling	Lower active power

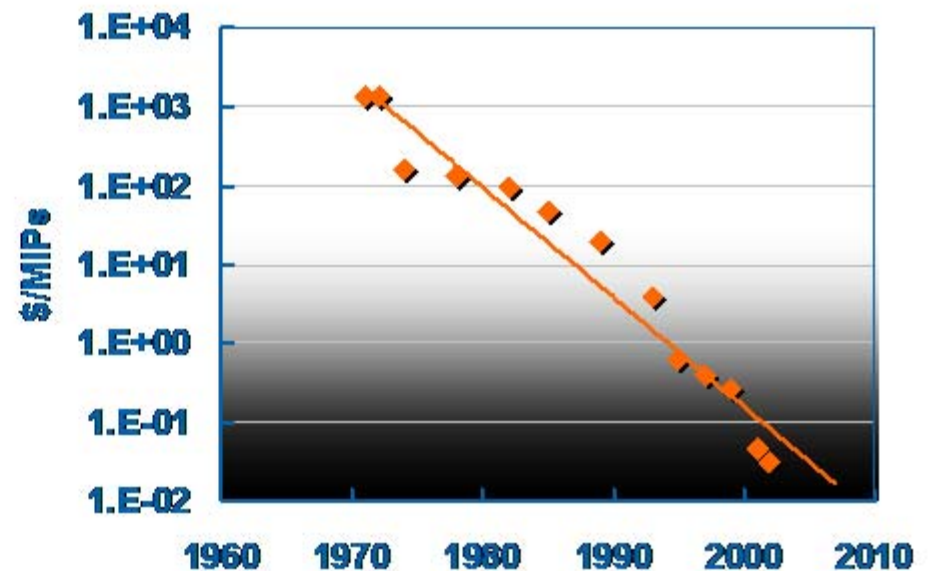
Computing Affordability

\$ per Transistor



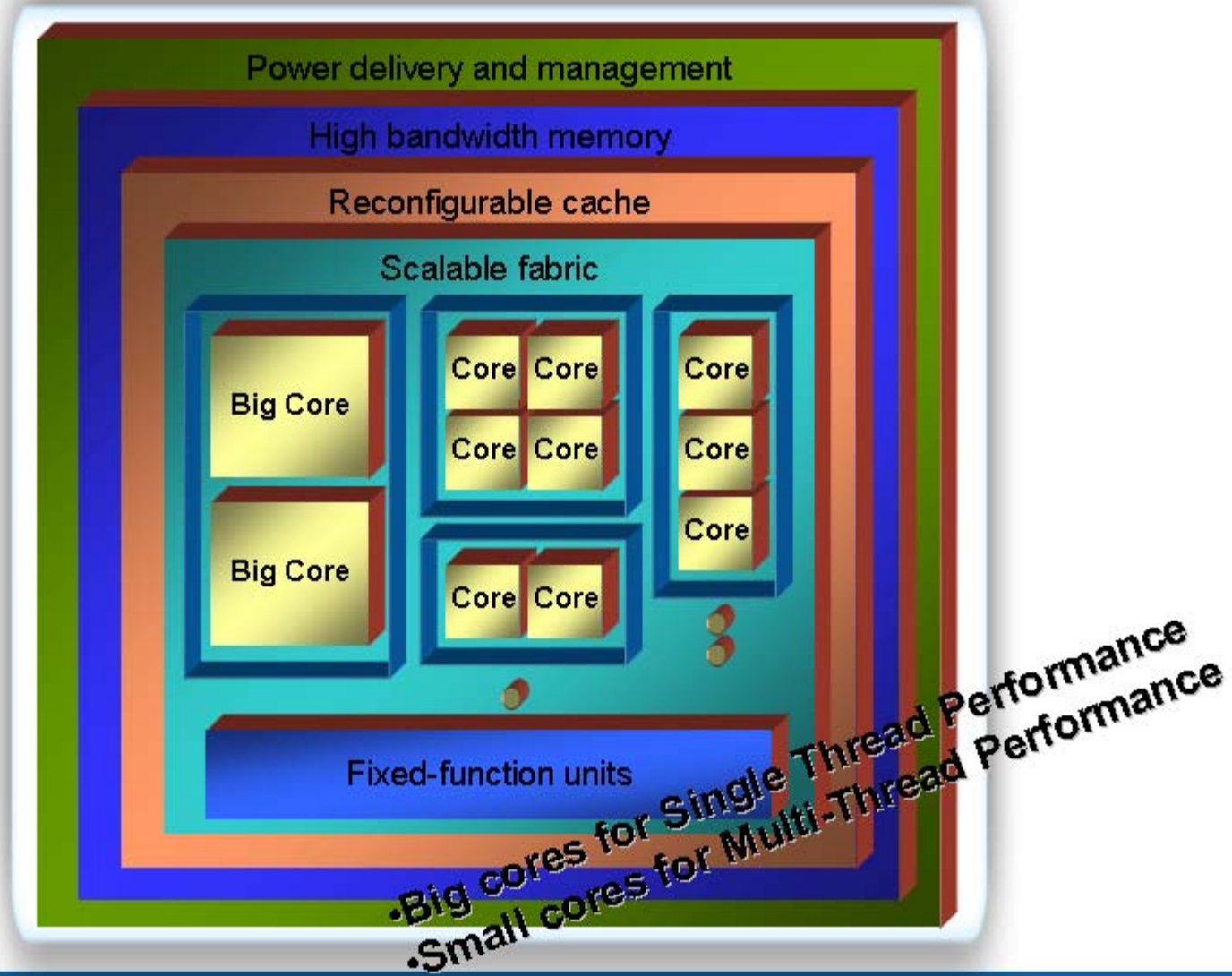
Source: Intel

\$ per MIPS



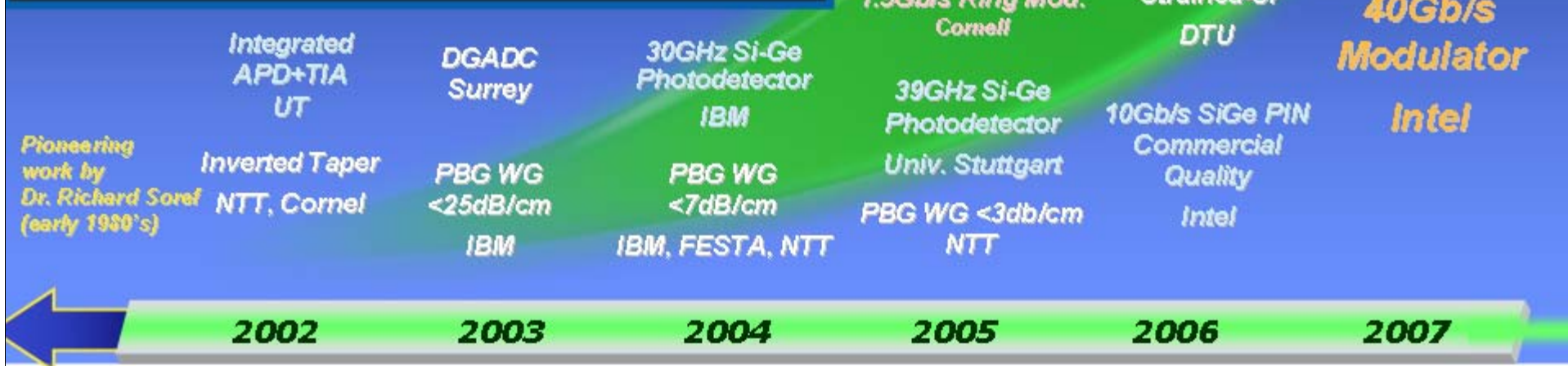
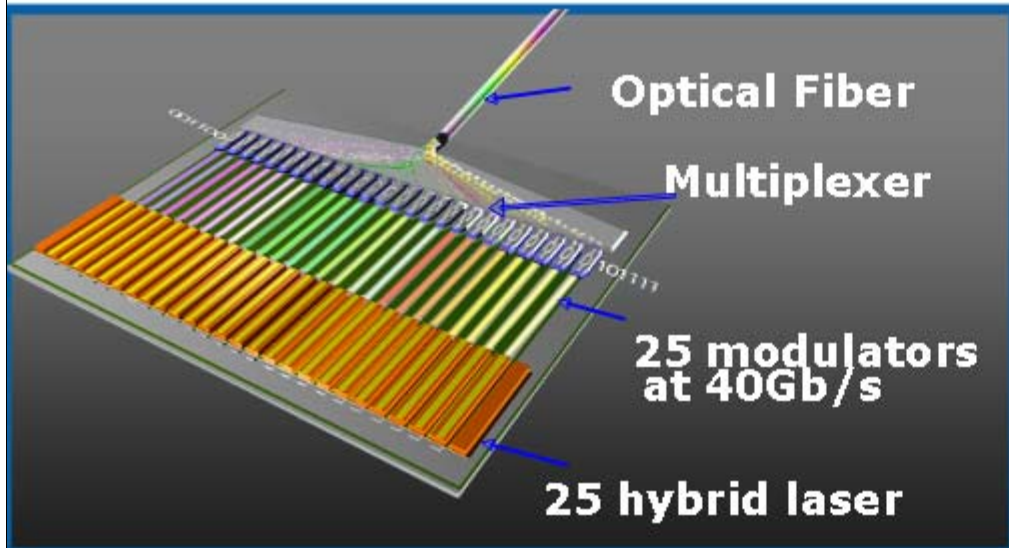
"Supercomputer prices range from about \$1 million to \$20 million, but in terms of constant dollars, the \$10 million average is a useful rule of thumb over about 3 decades." - source: "Characteristics of High-Performance Computers," 1989, Jack Worlton

Accelerating Multi- and Many-core



Performance Through Parallelism

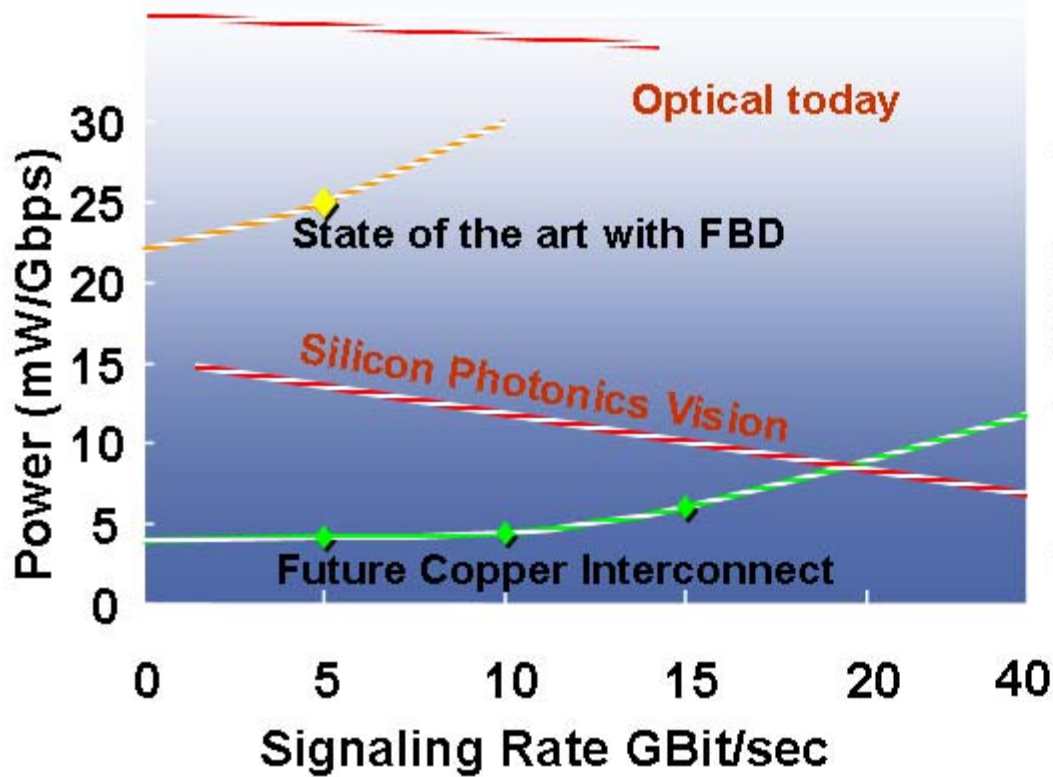
Future Silicon Photonics at the Cost of Silicon



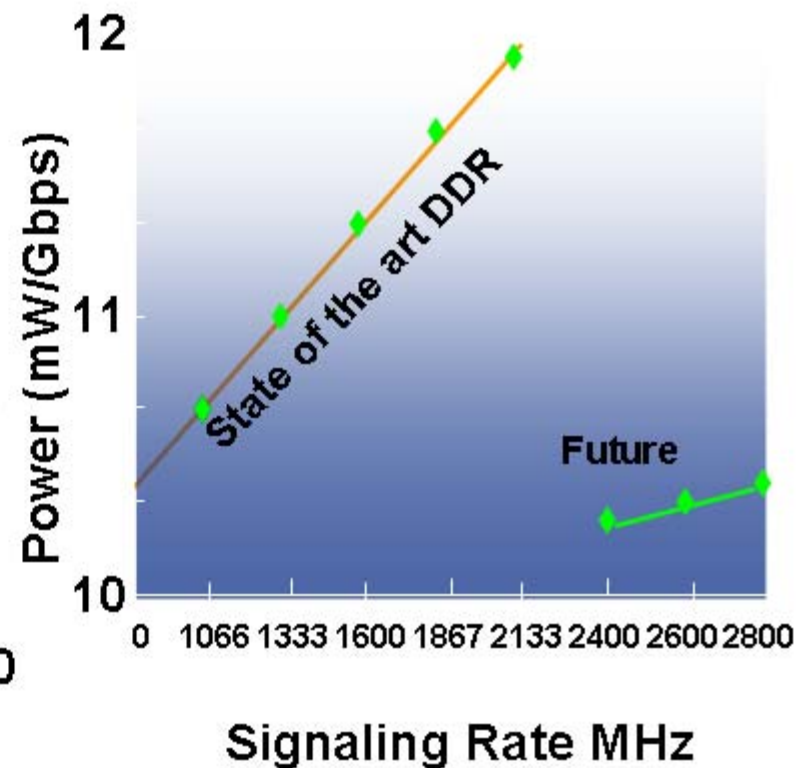
Note: Not an exhaustive list

Increasing Signaling Rate

More Bandwidth & Less Power



Differential Copper Interconnect & Silicon Photonics

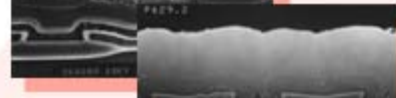


Single-ended Interconnect

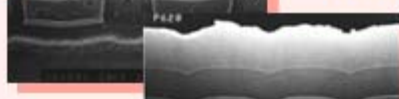
Technologies for Smaller and Better Flash Memory



1986/1.5µm ← 36µm² Cell = 16F²



1988/1.0µm ← "Boot Block"



1991/0.8µm ← Intel FlashFile™ Memory



1993/0.6µm ← 10F² cell, Flash Takes Over EpROM



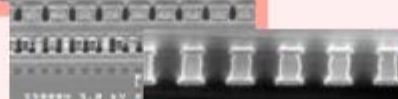
1996/0.4µm ← First MLC



1998/0.25µm ← Wireless Boom



2000/0.18µm ← 4.9F² eff. cell



2002/0.13µm ← 1.8V ISF



2004/90nm
← 4.7F² effective cell

Base cell has shrunk 16F² to 5F²

Technology was optimized over several generations

Personalize Bigger and More Powerful Engine

Tomorrow's Personal Computing

Today's HPC Performance
Vs.
Efficient Power + Small Space



CERN OpenLab, Intel HPC Roundtable '06

Becomes this?



Driving to the Future:

New Generation of Mass Computing

Wall-street, Google, Pixar/ILM, SecondLife...

Computer Vision

Rendering

Physical Simulation

Financial Analytics

Data mining

Grange Challenge Problems

- Field containment for Nuclear fusion
- Multi modal fluid structures problems
- Modeling materials' behaviors in phase change
- Many more...